

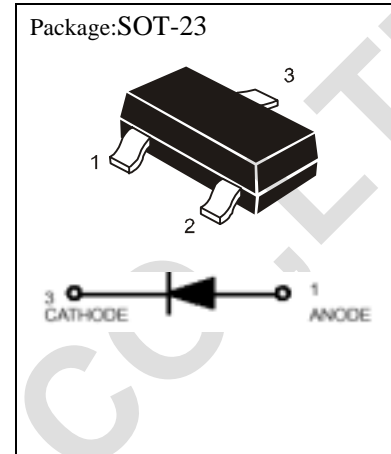
SURFACE MOUNT SWITCHING DIODE

- Low Leakage Current Applications
- Medium Speed Switching Times

**ABSOLUTE MAXIMUM RATINGS at Ta=25°C**

Characteristic	Symbol	Rating	Unit
Non-Repetitive Peak Reverse Voltage	$V_{RM}$	100	V
Peak Repetitive Reverse Voltage	$V_{RRM}$	75	V
working Peak Reverse Voltage	$V_{RWM}$		
DC Blocking Voltage	$V_R$		
Peak Forward Current	$I_F$	200	mAdc
Forward Continuous Current(Note)	$I_{FM}$	300	mAdc
Power Dissipation (Note)	$P_D$	300	mW
Derate Above 25°C		2.4	mW/°C
Junction Temperature	$T_j$	150	°C
Storage Temperature	$T_{stg}$	-50-150	°C

Note:Diode Ceramic Substrate 10mm × 8.0mm × 0.7mm



**ELECTRICAL CHARACTERISTICS at Ta=25°C**

Characteristic	Symbol	Min	Max	Unit	Test Conditions
Forward Voltage	$V_F$		0.9	V	$I_F=1.0mA$
			1.0	V	$I_F=10mA$
			1.1	V	$I_F=50mA$
			1.25	V	$I_F=150mA$
Reverse Breakdown Voltage	$V_{(BR)}$	75	—	Vdc	$I_{BR} = 100 \mu A_{dc}$
Reverse Voltage Leakage Current	$I_R$		5.0	$\mu A$	$V_R=75V$
			80	nA	$V_R=75V T_j=150^\circ C$
Capacitance	$C_j$		2.0	PF	$V_R=0 f=1.0MHz$
Reverse Recovery Time	$T_{rr}$		3.0	$\mu S$	$I_F=10mA$ to $I_R=10mA$

Note:Diode On Ceramic Substrate 10mm × 8.0mm × 0.7mm

**DEVICE MARKING:**

BAS116LT1=JV